

Base Band Hue/Color Control

Description

The CXA2039M is a bipolar color difference signal processing IC for color TVs. This chip enables base band hue and color control for color difference signals.

Features

- 2 UV inputs, 1 UV output
- 3 Y inputs, 2 Y outputs
(1 of the 2 outputs outputs either of 2 inputs.)
- Built-in color difference signal delay line circuit

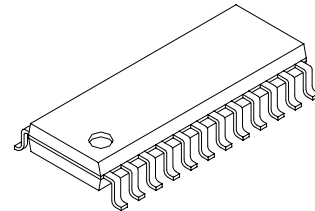
Absolute Maximum Ratings

- | | | | |
|-------------------------------|------------------|-------------|----|
| • Supply voltage | V _{cc} | 12 | V |
| • Operating temperature | T _{opr} | −20 to +75 | °C |
| • Storage temperature | T _{stg} | −65 to +150 | °C |
| • Allowable power dissipation | P _d | 780 | mW |

Operating Conditions

- | | | | |
|----------------|-----------------|---------|---|
| Supply voltage | V _{cc} | 9 ± 0.5 | V |
|----------------|-----------------|---------|---|

24 pin SOP (Plastic)



Applications

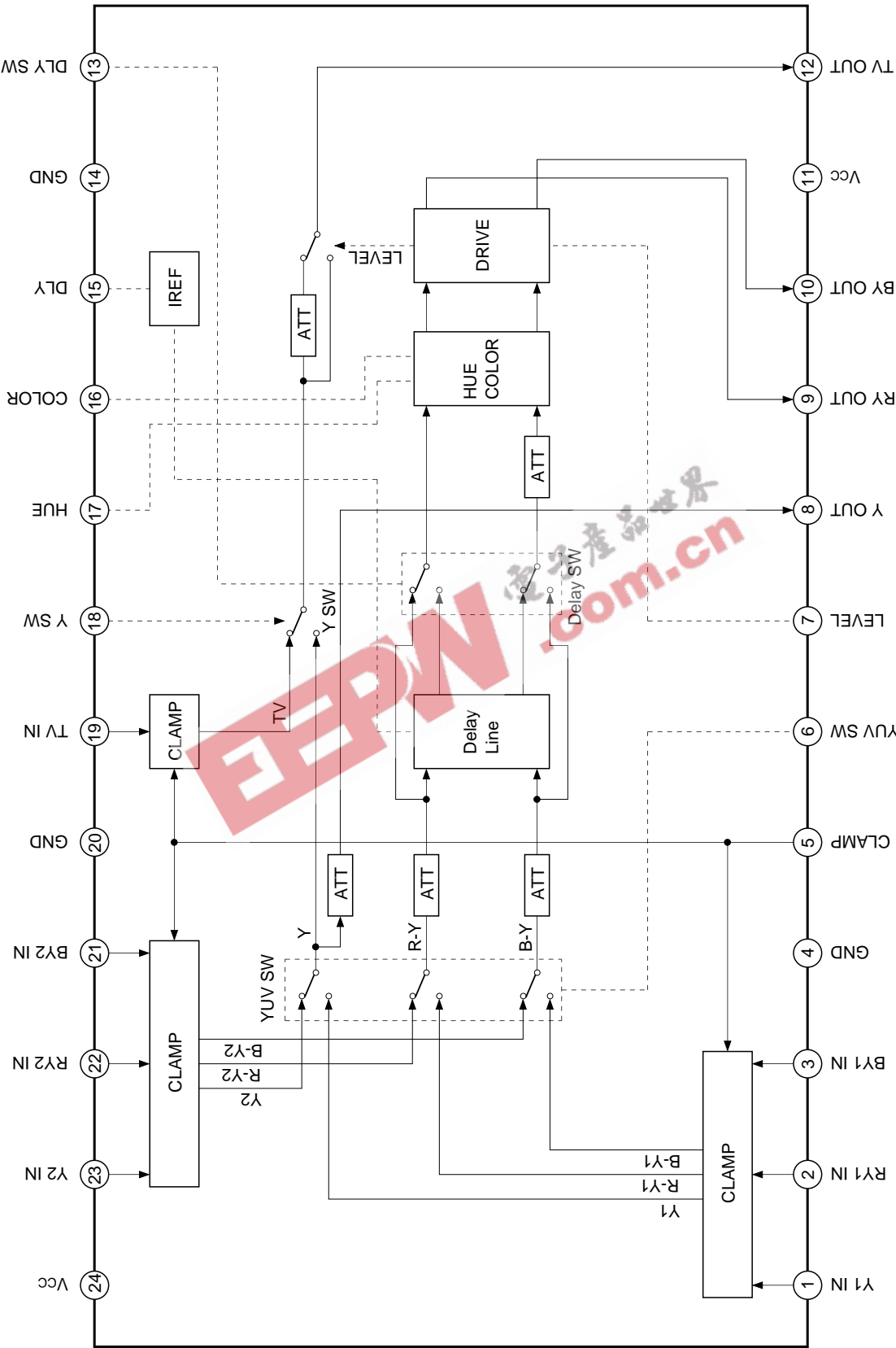
Color TVs

Structure

Bipolar silicon monolithic IC

Sony reserves the right to change products and specifications without prior notice. This information does not convey any license by any implication or otherwise under any patents or other right. Application circuits shown, if any, are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits.

Block Diagram



Pin Description

Pin No.	Symbol	Pin voltage	Equivalent circuit	Description
1 2 3	Y1 IN RY1 IN BY1 IN			Y1, R-Y1 and B-Y1 signal inputs. Input the signals via capacitors.
4 14 20	GND			GND.
5	CLAMP			Clamp pulse (positive polarity) input. $V_{ILMAX} = 2.5V$ $V_{IHMIN} = 3.5V$
6	YUV SW			YUV SW control. $YUV SW \leq 0.4V \rightarrow Y2 IN, RY2 IN,$ and BY2 IN signals selected. $YUV SW \geq 1.0V \rightarrow Y1 IN, RY1 IN,$ and BY1 IN signals selected.
7	LEVEL			RY OUT, BY OUT and TV OUT output level control. $V_{ILMAX} = 6.0V$ $V_{IHMIN} = 6.8V$
8	Y OUT			Y signal output. Outputs the signals input to Pins 1 and 23 attenuated by -6dB.

Pin No.	Symbol	Pin voltage	Equivalent circuit	Description
9	RY OUT			R-Y signal output.
10	BY OUT			B-Y signal output.
11 24	Vcc	9V		Power supply.
12	TV OUT			Y signal output.
13	DLY SW			<p>Delay on/off switching signal input.</p> <p>DLY SW $\leq 1.4V \rightarrow$ Delay off</p> <p>DLY SW $\geq 2.2V \rightarrow$ Delay on</p>
15	DLY			<p>Delay line reference current setting. Connect to GND via a resistor. When 10kΩ is connected, the delay time is 600ns. Increasing the resistance value increases the delay time and vice versa.</p>

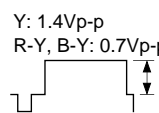
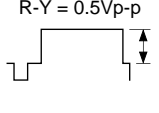
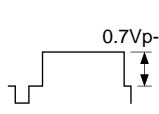
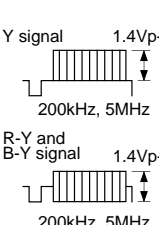
Exercise 18: A circuit diagram showing a PNP transistor in common emitter configuration. The emitter is connected to ground. The base is connected to a voltage divider consisting of two diodes in series, with the top diode connected to V_{CC} and the bottom diode connected to ground. A 1.5k resistor is connected between the base and the emitter. The collector is connected to V_{CC} through a load resistor. The output voltage is measured across the load resistor.

Exercise 19: A circuit diagram showing an NPN transistor in common emitter configuration. The emitter is connected to ground. The base is connected to a voltage divider consisting of a diode connected to V_{CC} and a resistor connected to ground. The collector is connected to V_{CC} through a load resistor. The output voltage is measured across the load resistor.

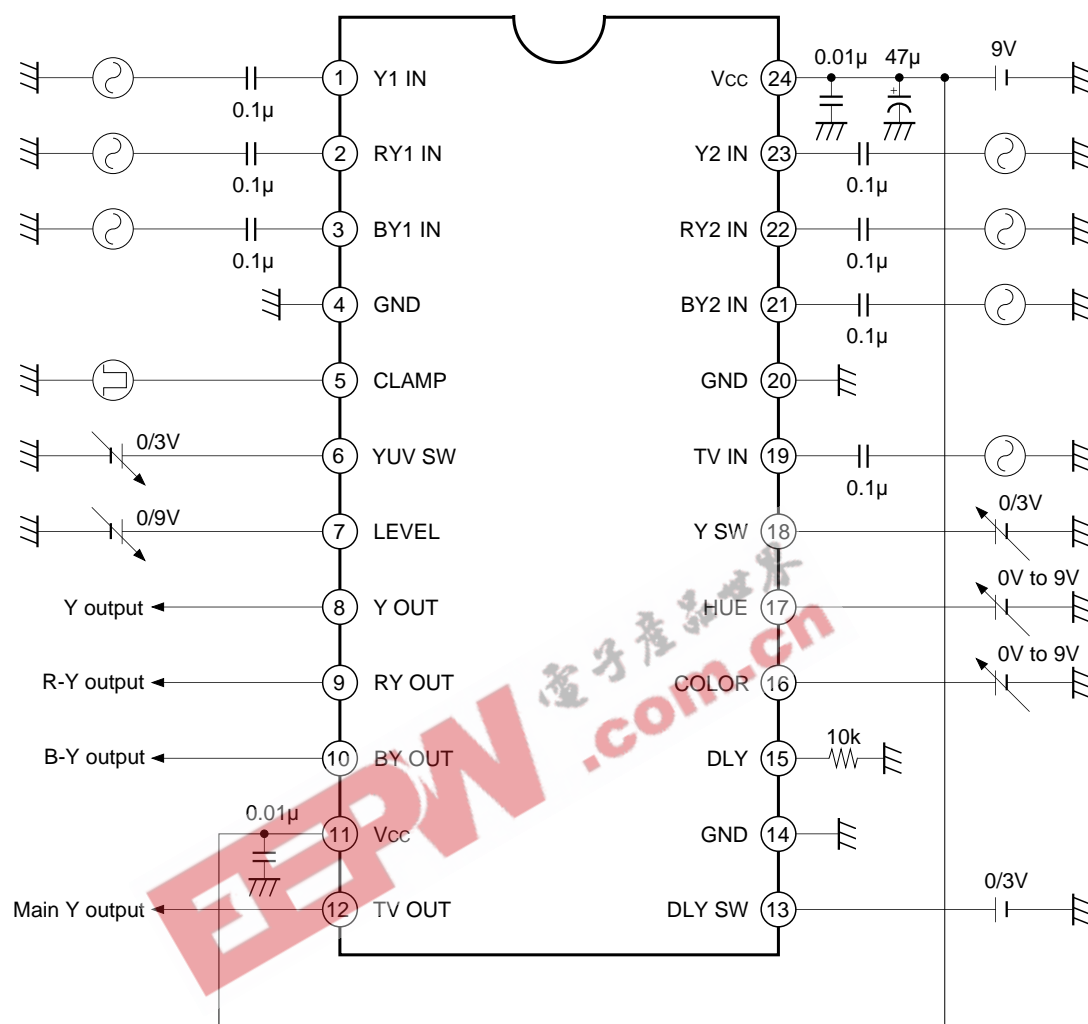
Electrical Characteristics

Setting conditions

- Ta = 25°C Vcc = 9V
- Set initially to: YUV SW = 0V, LEVEL = 0V, DLY SW = 0V, COLOR = 4.5V, HUE = 4.5V, Y SW = 0V.
(when inputting the signals from Y2 IN, RY2 IN and BY2 IN)

No.	Item	Symbol	Measurement pin	Input signal	Measurement conditions and contents		Min.	Typ.	Max.	Unit
1	Current consumption	Icc	11 24		Vcc pin inflow current		14	19	24	mA
2	TV OUT output gain	VTV1	12	 <p>Y: 1.4Vp-p R-Y, B-Y: 0.7Vp-p</p>	I/O gain	Gain SW = Low MODE LEVEL ≤ 6V	-7.0	-6.2	-5.0	dB
3	TV OUT output gain	VTV2	12			Gain SW = High MODE LEVEL ≥ 6.8V	-1.0	0	1.0	dB
4	Y OUT output gain	VY	8		I/O gain		-7.0	-6.2	-5.0	dB
5	RY OUT output gain	VRV1	9		I/O gain	Gain SW = Low MODE LEVEL ≤ 6V	-7.0	-5.3	-4.0	dB
6	RY OUT output gain	VRV2	9			Gain SW = High MODE LEVEL ≥ 6.8V	-6.6	-4.7	-4.0	dB
7	BY OUT output gain	VBY1	10		I/O gain	Gain SW = Low MODE LEVEL ≤ 6V	-4.7	-3.1	-1.7	dB
8	BY OUT output gain	VBY2	10			Gain SW = High MODE LEVEL ≥ 6.8V	-4.3	-2.3	-1.3	dB
9	Color variable range 1	Cmax.	9		Set the output when COLOR = 4.5V to 0dB and measure the output when COLOR = 9V.		5.3	6.1	6.8	dB
10	Color variable range 2	Cmin.	9	Set the output when COLOR = 4.5V to 0dB and measure the output when COLOR = 0 V.			-40	-30	dB	
11	Hue variable range 1	Hmax.	10	 <p>B-Y = 0.7Vp-p R-Y = 0.5Vp-p</p>	$\tan^{-1} = \frac{\text{Output level during RY signal input only}}{\text{Output level during BY signal input only}}$ when HUE = 9V		40	48		Deg.
12	Hue variable range 2	Hmin.	10		$\tan^{-1} = \frac{\text{Output level during RY signal input only}}{\text{Output level during BY signal input only}}$ when HUE = 0V			-48	-40	Deg.
13	RY OUT Delay	RYDLY	9	 <p>0.7Vp-p</p>	DLY SW = 3V. Measure the I/O delay.		530	600	680	ns
14	BY OUT Delay	BYDLY	10		DLY SW = 3V. Measure the I/O delay.		530	600	680	ns
15	Y OUT frequency response	fY	8	 <p>Y signal 1.4Vp-p 200kHz, 5MHz R-Y and B-Y signal 1.4Vp-p 200kHz, 5MHz</p>	Y SW = 3V. Measure the 200kHz gain with respect to 5MHz.		-1.0	0	1.0	dB
16	RY OUT frequency response	fRY	9				-6.0	-3.5	0	dB
17	BY OUT frequency response	fBY	10				-8.0	-5.0	-1.0	dB
18	TV OUT frequency response	fTV	12				-1.0	0	1.0	dB

Electrical Characteristics Measurement Circuit



* When performing measurements with signals input from Y1 IN, RY1 IN and BY1 IN: YUV
SW = 3V

When performing measurements with signals input from Y2 IN, RY2 IN and BY2 IN: YUV
SW = 0V

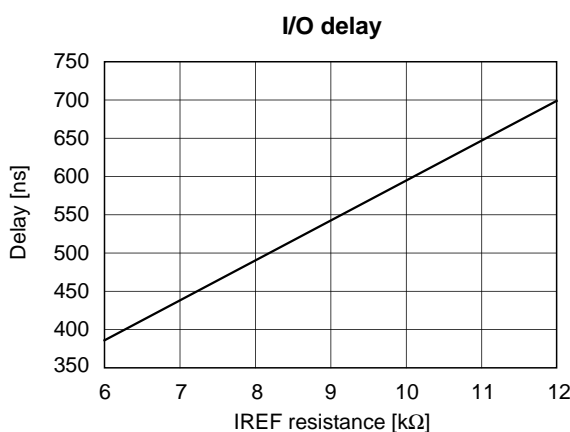
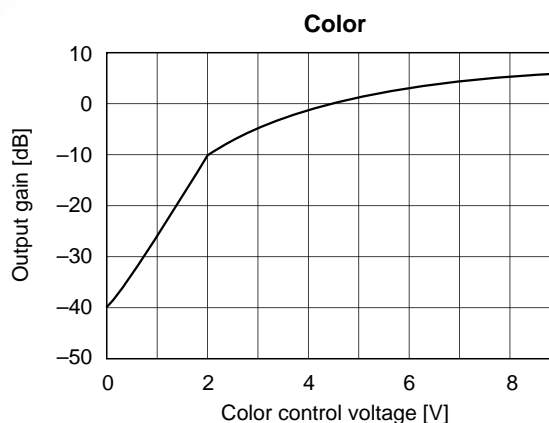
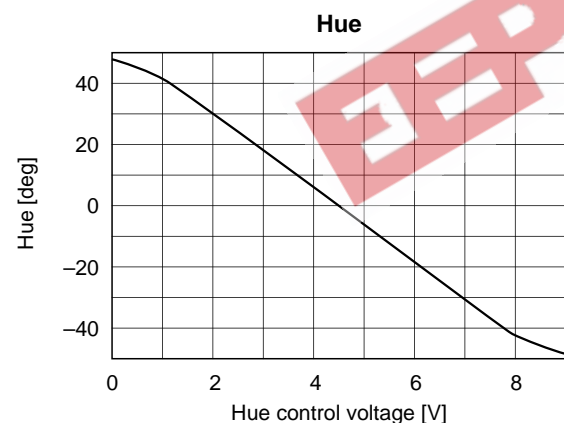
Description of Operation

The Y, R-Y and B-Y signals input from Pins 1, 2, 3, 21, 22 and 23 are clamped by the clamp circuit and sent to the YUV SW circuit. The Y signal input from Pin 19 is clamped by the clamp circuit and then sent to the Y SW circuit.

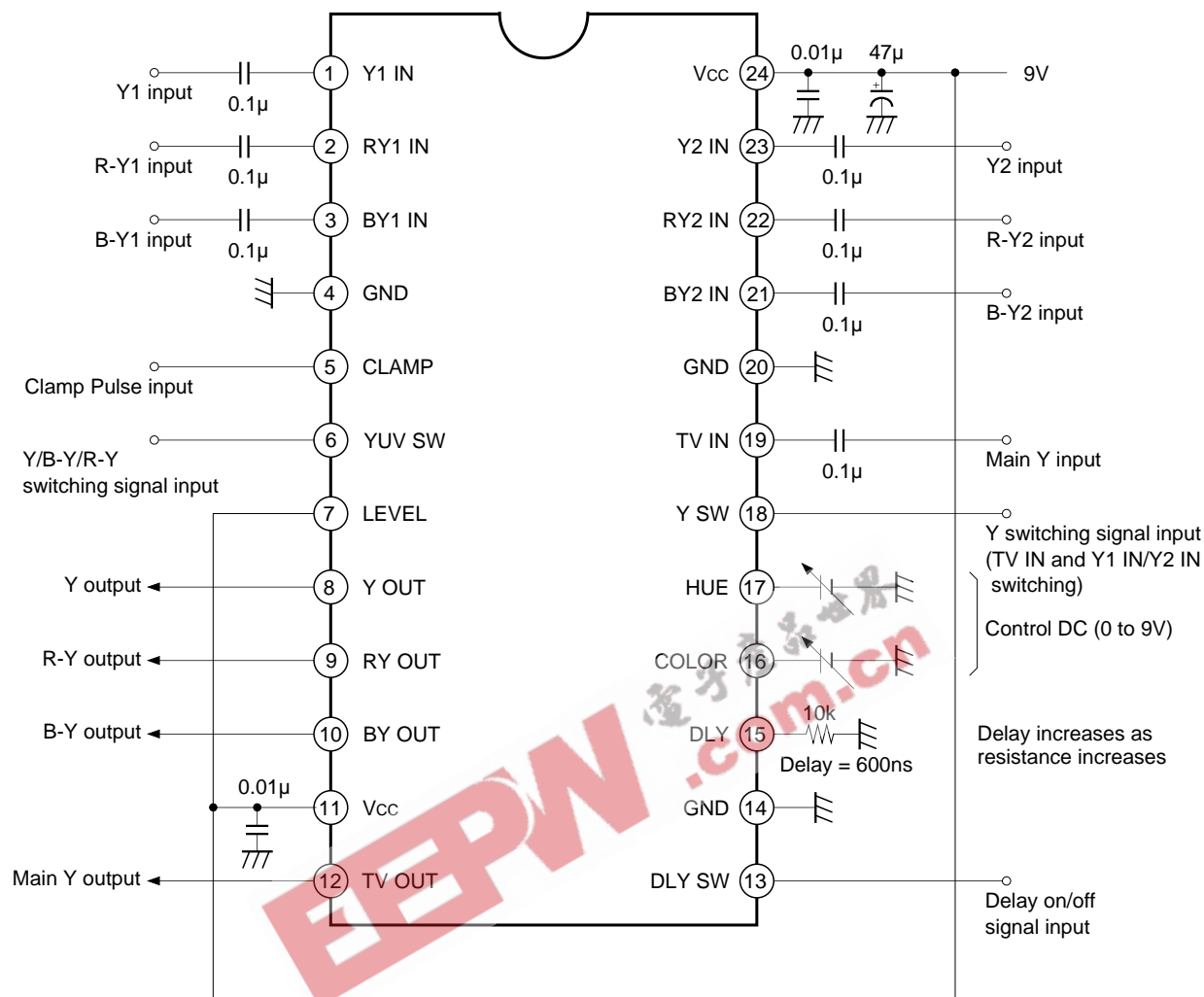
The YUV SW circuit receives the switching signal from Pin 6 and selects either the signals from Pins 1, 2 and 3 or from Pins 21, 22 and 23. The R-Y and B-Y signals output from the YUV SW circuit are attenuated and sent to the delay line and delay switch circuits. The delay time at the delay line circuit can be set as desired in the range of 500 to 700ns according to the resistance value connected between Pin 15 and GND. After passing through the delay line circuit, the signals are sent to the delay switch circuit where the Pin 13 control voltage is received and delay on/off switching is performed. The signals output from the delay switch circuit are input to the base band hue and color control circuits where the Pins 16 and 17 control voltages are received and hue and color control is performed. Then, the signals are amplified by the drive circuit and output from Pins 9 and 10. The drive circuit gain can be switched between two values according to the voltage applied to Pin 7. Two types of Y signals, 0dB and -6dB with respect to the input level, are output from the YUV SW circuit. The 0dB signal is sent as is to the Y SW circuit, and the -6dB signal is output from Pin 8.

The Y SW circuit receives the switching signal from Pin 18 and selects the Pin 19 signal and either the Pin 1 or Pin 23 signal selected by YUV SW. Two types of Y signals, an unadjusted signal and a signal attenuated by -6dB, are output from the Y SW circuit. These signals are sent to the level switch circuit where one of them is selected according to the voltage applied to Pin 7 and output from Pin 12.

Curve Data

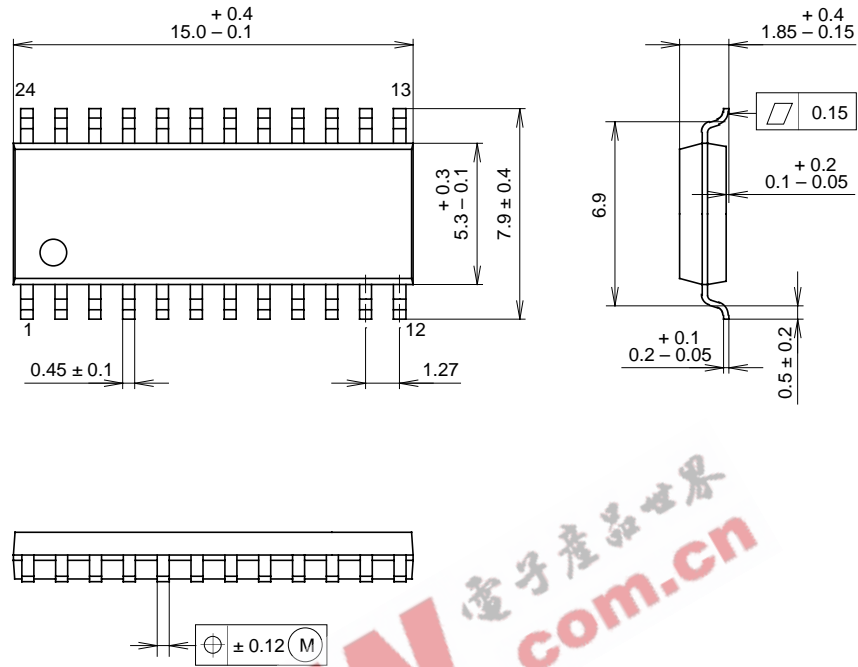


Application Circuit



Package Outline Unit: mm

24PIN SOP (PLASTIC)



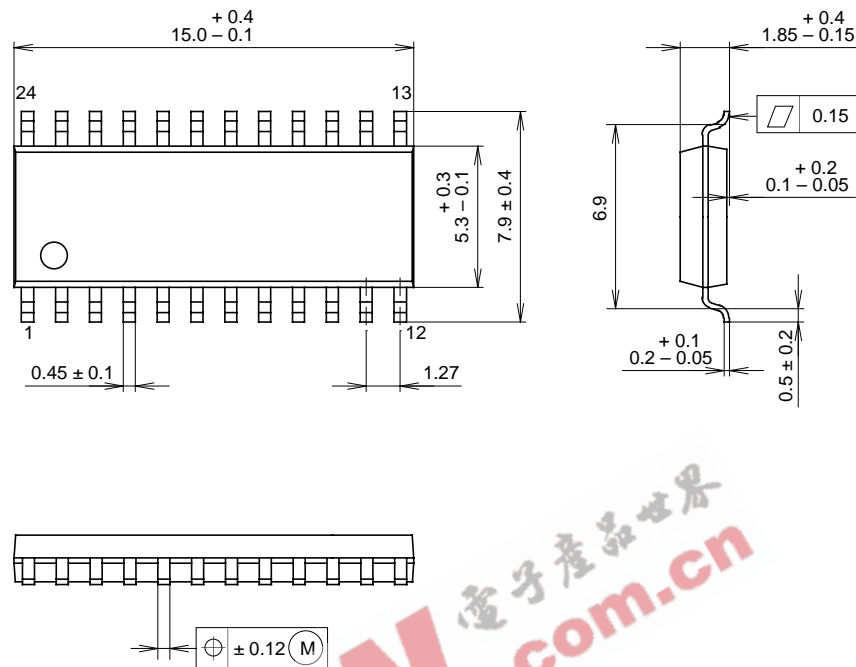
SONY CODE	SOP-24P-L01
EIAJ CODE	*SOP024-P-0300-A
JEDEC CODE	—

PACKAGE STRUCTURE

MOLDING COMPOUND	EPOXY/PHENOL RESIN
LEAD TREATMENT	SOLDER PLATING
LEAD MATERIAL	COPPER ALLOY / 42ALLOY
PACKAGE WEIGHT	0.3g

Package Outline Unit: mm

24PIN SOP (PLASTIC)



PACKAGE STRUCTURE

SONY CODE	SOP-24P-L01
EIAJ CODE	*SOP024-P-0300-A
JEDEC CODE	

MOLDING COMPOUND	EPOXY/PHENOL RESIN
LEAD TREATMENT	SOLDER PLATING
LEAD MATERIAL	COPPER ALLOY / 42ALLOY
PACKAGE WEIGHT	0.3g

LEAD PLATING SPECIFICATIONS

ITEM	SPEC.
LEAD MATERIAL	COPPER ALLOY
SOLDER COMPOSITION	Sn-Bi Bi:1-4wt%
PLATING THICKNESS	5-18 μ m